

## Features

- Transient protection for high-speed data lines  
IEC 61000-4-2 (ESD)  $\pm 25\text{kV}$  (Air)  
 $\pm 17\text{kV}$  (Contact)  
IEC 61000-4-4 (EFT) 40A (5/50 ns)  
Cable Discharge Event (CDE)
- Package optimized for high-speed lines
- Ultra-small package (2.5mmx1.0mmx0.55mm)
- Protect six data lines
- Low capacitance: 0.2pF Typical(I/O-I/O)
- Low leakage current: 0.1uA@ $V_{RWM}$  (Typical)
- Low clamping voltage
- Each I/O pin can with stand over 1000 ESD strikes for  $\pm 8\text{kV}$  contact discharge

## Description

T0524SP is an ultra-low capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for high-speed data interfaces. With typical capacitance of 0.2 pF only, T0524SP is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2 (ESD), Level 4 ( $\pm 15\text{kV}$  air,  $\pm 8\text{kV}$  contact discharge), IEC 61000-4-4 (electrical fast transient - EFT) (40A, 5/50 ns), very fast charged device model (CDM) ESD and cable discharge event (CDE), etc.

T0524SP uses ultra-small DFN2510-10L package. Each T0524SP device can protect four high-speed data lines. The combined features of ultra-low capacitance, ultra-small size and high ESD robustness make T0524SP ideal for high-speed data ports and high-frequency lines (e.g., HDMI & DVI) applications. The low clamping voltage of the T0524SP guarantees a minimum stress on the protected IC.

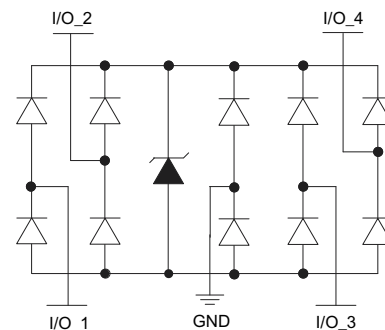
## Applications

- Serial ATA
- PCI Express
- Desktops, Servers and Notebooks
- MDDI Ports
- USB 2.0/3.0/3.1 Power and Data Line Protection
- Display Ports
- High Definition Multi-Media Interface (HDMI 1.4/2.0)
- Digital Visual Interfaces (DVI)

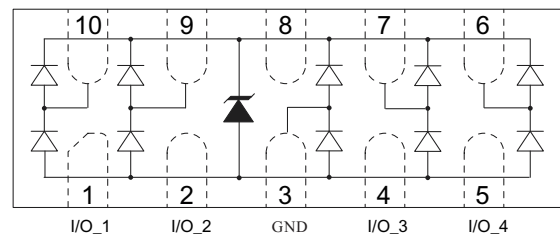
## Mechanical Characteristics

- DFN2510-10L package
- Flammability Rating: UL 94V-0
- Packaging: Tape and Reel

## Circuit Diagram



## Pin Configuration



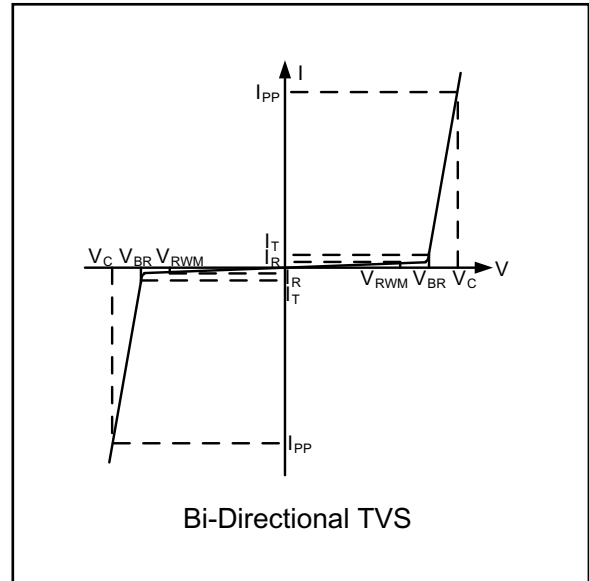
DFN2510-10L  
(Top View)

### Absolute Maximum Rating

Symbol	Parameter	Value	Units
$V_{ESD}$	ESD per IEC 61000-4-2 (Air)	$\pm 25$	kV
	ESD per IEC 61000-4-2 (Contact)	$\pm 17$	
$T_{OPT}$	Operating Temperature	-55/+125	$^{\circ}C$
$T_{STG}$	Storage Temperature	-55/+150	$^{\circ}C$

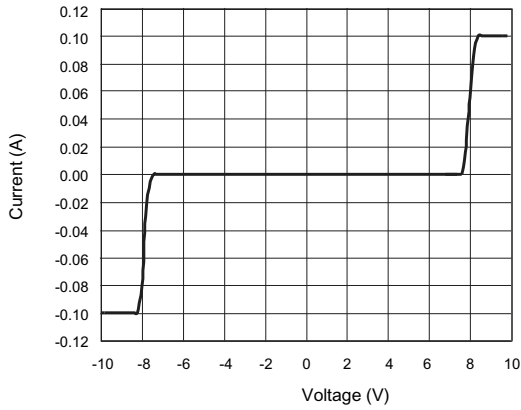
### Electrical Characteristics (T = 25 $^{\circ}C$ )

Symbol	Parameter
$V_{RWM}$	Nominal Reverse Working Voltage
$I_R$	Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Reverse Breakdown Voltage @ $I_T$
$I_T$	Test Current for Reverse Breakdown
$V_C$	Clamping Voltage @ $I_{PP}$
$I_{PP}$	Maximum Peak Pulse Current
$C_{ESD}$	Parasitic Capacitance
$V_R$	Reverse Voltage
f	Small Signal Frequency
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$

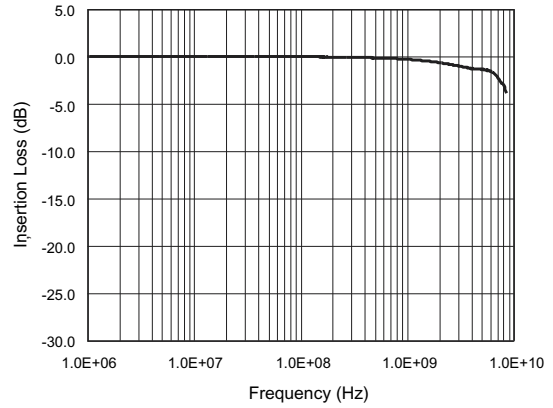


Symbol	Test Condition	Minimum	Typical	Maximum	Units
$V_{RWM}$				5.0	V
$I_R$	$V_{RWM} = 5V, T = 25^{\circ}C$ Between I/O and GND		0.1	1.0	$\mu A$
$V_{BR}$	$I_T = 1mA$ Between I/O and GND	7.0	9.0	11.0	V
$V_C$	$I_{PP} = 1A, t_p = 8/20\mu s$ Between I/O and GND			12	V
$C_{ESD}$	$V_R = 0V, f = 1MHz$ Between I/O and GND		0.2	0.3	pF
$C_{ESD}$	$V_R = 0V, f = 1MHz$ Between I/O and I/O		0.2	0.3	pF

### Voltage Sweeping of I/O to GND

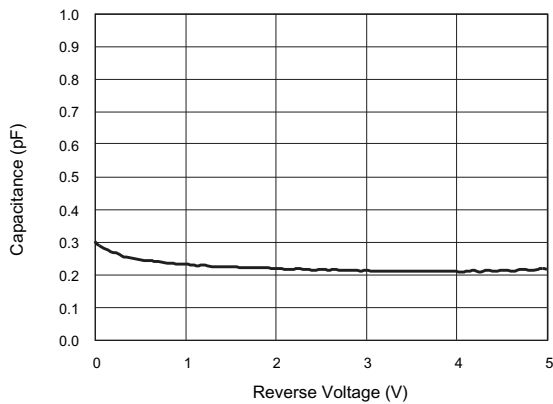


### Insertion Loss S21 of I/O to GND

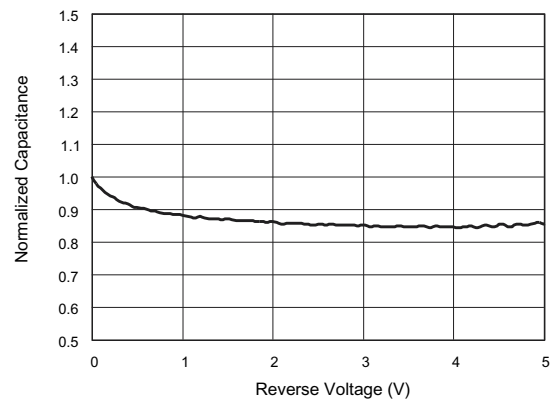


### Capacitance vs. Voltage of I/O to GND (f = 1MHz)

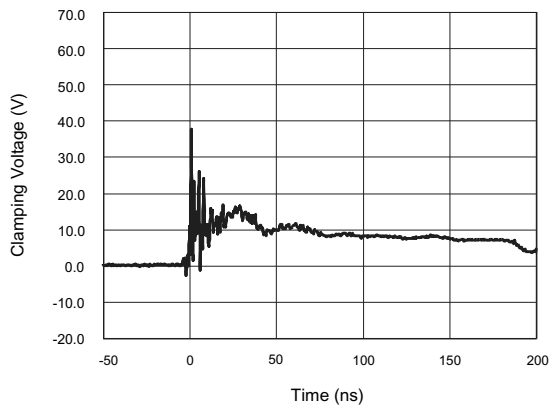
Capacitance vs. Reverse Voltage



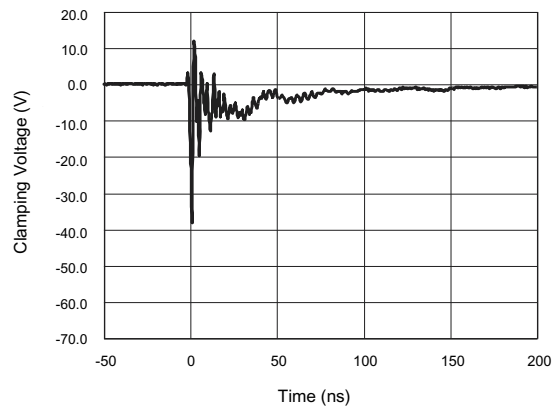
Normalized Capacitance vs. Reverse Voltage



### ESD Clamping of I/O to GND (+8kV Contact per IEC 61000-4-2)



### ESD Clamping of I/O to GND (-8kV Contact per IEC 61000-4-2)



## Application Information

### Pin Connection in PCB

T0524SP provides ESD protection for four data lines simultaneously. The pin connection is shown in the figure below.

Four parallel data lines, from inner IC to I/O port connector, could connect to T0524SP four I/O pins directly. Pin 3 of T0524SP is the GND pin, which should connect to the GND of PCB. The wire should be as short as possible in order to minimize the parasitic inductance.

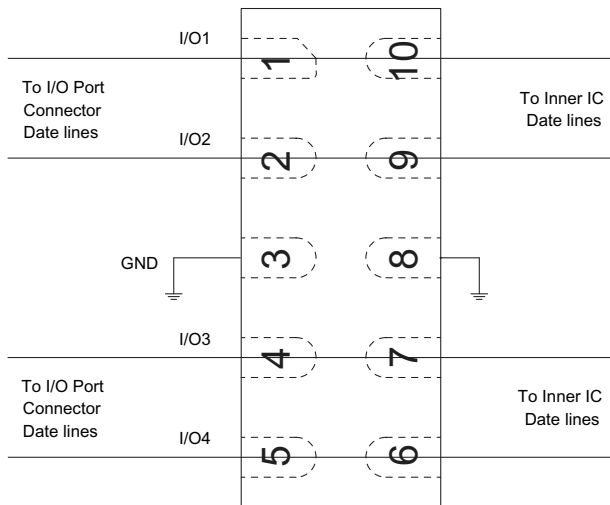


Figure 1 T0524SP pin connection in PCB

### PCB Layout Guidelines

For optimum ESD protection and the whole circuit performance, the following PCB layout guidelines are recommended:

- ❑ T0524SP GND pin to the PCB GND rail path should be as short as possible. It could reduce the ESD transient return path to GND.
- ❑ The vias connecting T0524SP GND pins to the PCB GND should be wide
- ❑ Place T0524SP as close to the connector port as possible. It could reduce the parasitic inductance and restrict ESD coupling into adjacent traces.
- ❑ Avoid running critical signals near board edges.

Application Information

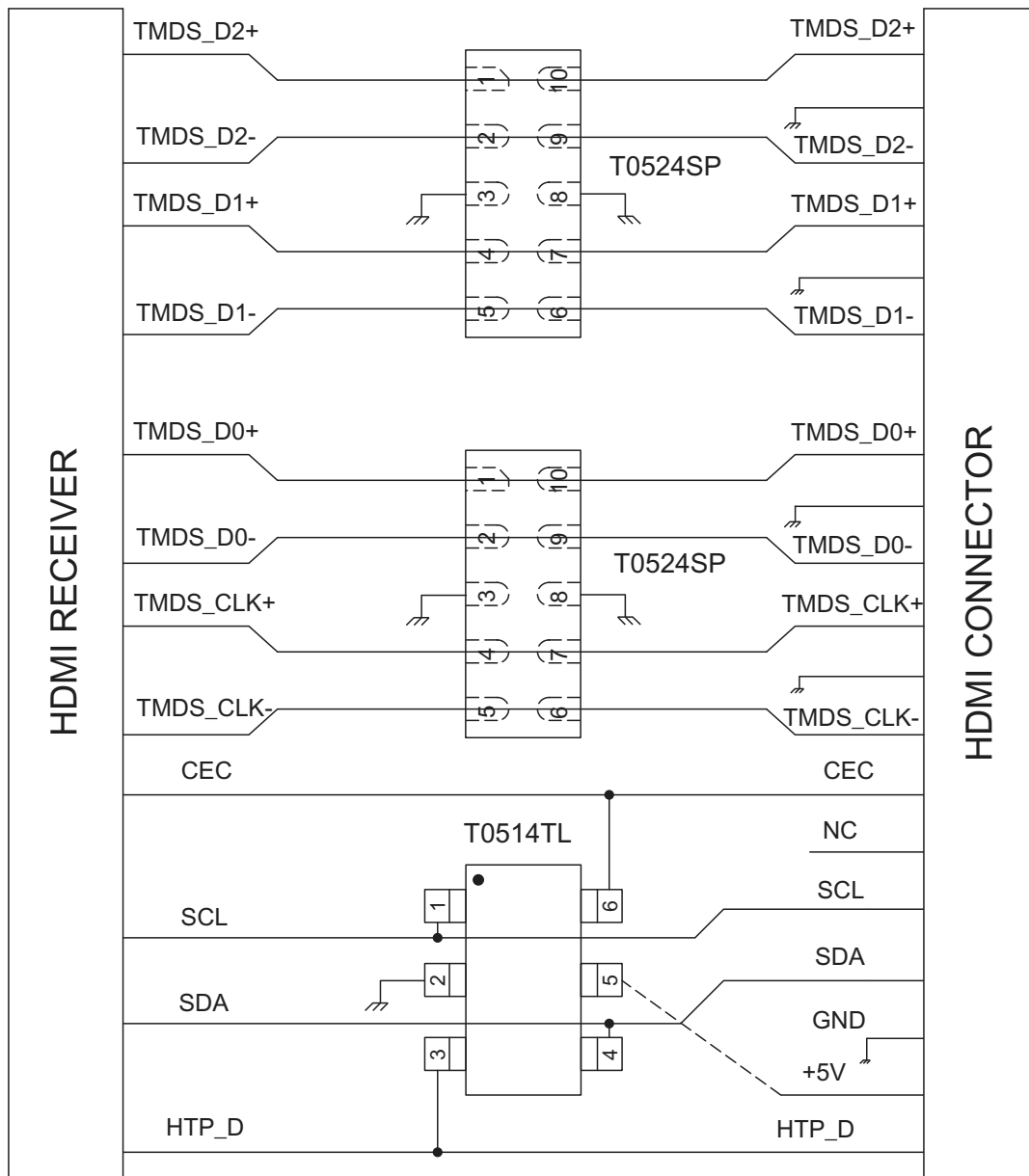
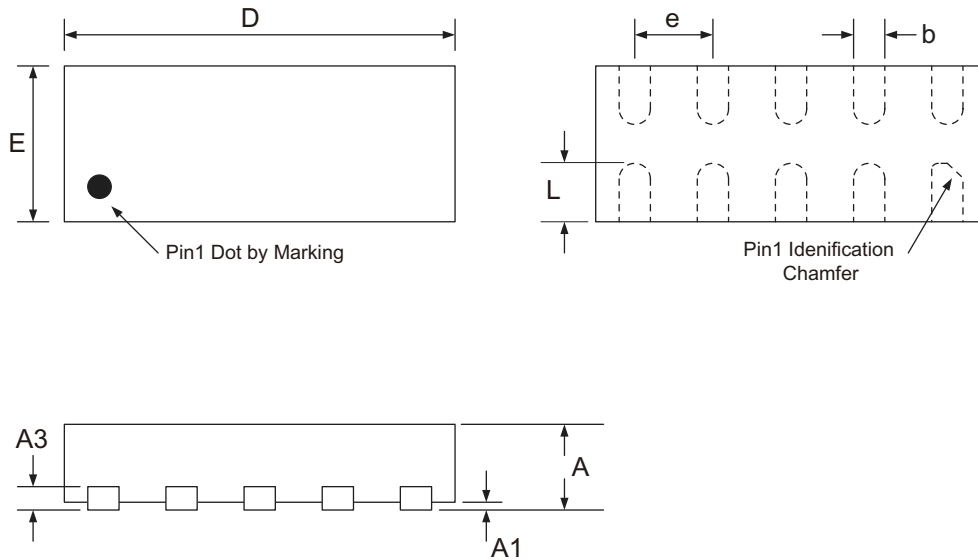


Figure 2 Layout Top View for HDMI Interface With T0524SP & T0514TL

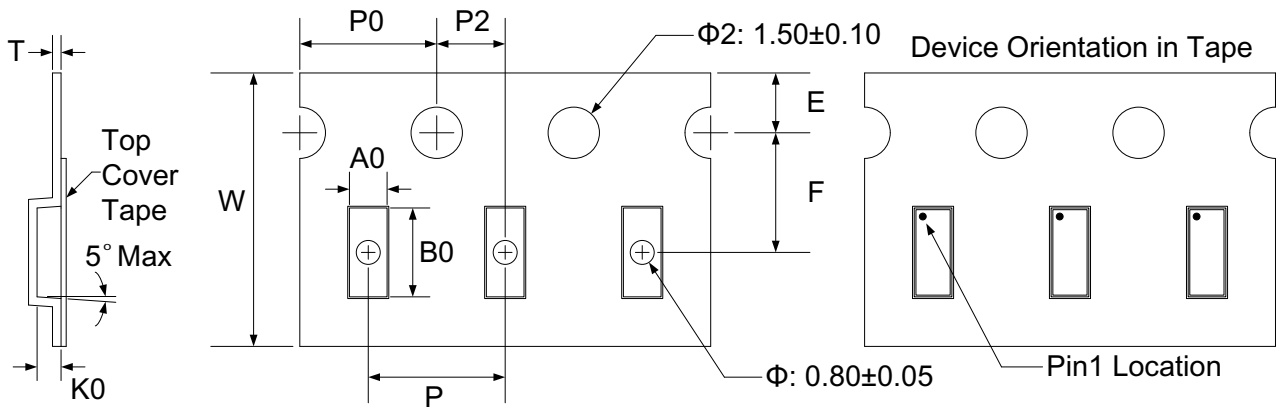
**Package Outline**

 DFN2510-10L package  
 Thermally-Enhanced  
 MSL-1 Level


Package Dimensions (Controlling dimensions are in millimetres)

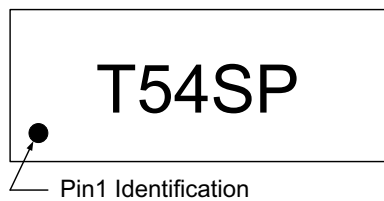
Symbol	Dimensions (mm)		Dimensions (inch)	
	Minimum	Maximum	Minimum	Maximum
A	0.500	0.600	0.020	0.024
A1	0.000	0.050	0.000	0.002
A3	0.150REF.		0.006REF.	
b	0.150	0.250	0.006	0.010
D	2.450	2.550	0.096	0.100
E	0.950	1.050	0.037	0.041
e	0.500 BSC		0.020 BSC	
L	0.300	0.400	0.012	0.016

## Tape and Reel Specification



Symbol	W	A0	B0	K0	E	F	P	P0	P2	T
Dimensions (mm)	$8.00^{+0.3}_{-0.1}$	$1.23 \pm 0.05$	$2.7 \pm 0.05$	$0.7 \pm 0.05$	$1.75 \pm 0.1$	$3.5 \pm 0.05$	$4.0 \pm 0.1$	$4.0 \pm 0.1$	$2.0 \pm 0.05$	$0.25 \pm 0.02$

## Marking Codes



Note:

- "T54SP" is part number, fixed.

## Ordering Information

Part Number	Working Voltage	Quantity Per Reel	Reel Size
T0524SP	5V	3,000	7 Inch

- CITC reserves the right to make changes to this document and its products and specifications at any time without notice.
- Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
- CITC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does CITC assume any liability for application assistance or customer product design.
- CITC does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.
- No license is granted by implication or otherwise under any intellectual property rights of CITC.
- CITC products are not authorized for use as critical components in life support devices or systems without express written approval of CITC.